Ceramic Plate Series CP14-199-045-L2-EP-W12
MFG Part Number: 430875-501

Ceramic Plate Series Thermoelectric Cooler

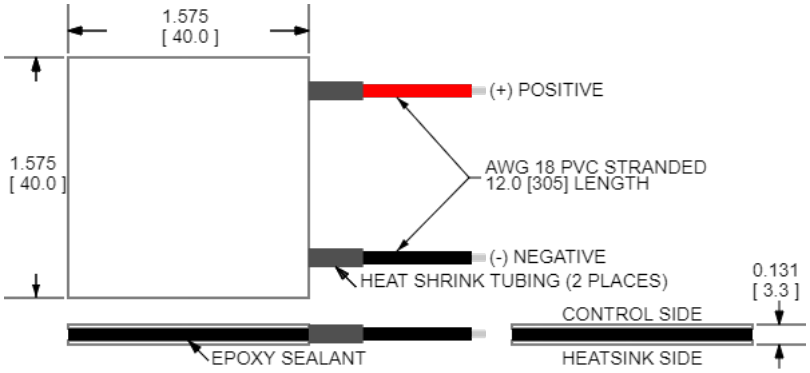
The CP14-199-045-L2-EP-W12 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum Qc of 111.8 Watts when ΔT = 0 and a maximum ΔT of 70.5 °C at Qc = 0.

Features

- Compact geometric sizes
- DC Operation
- RoHS-compliant

Applications

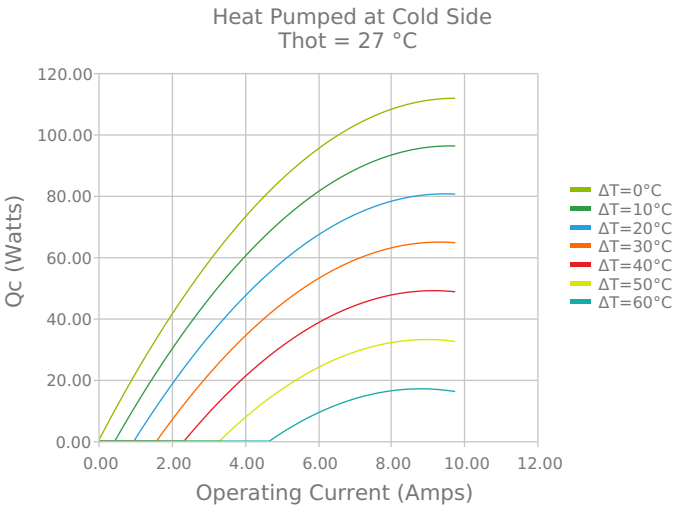
- Thermoelectric Coolers for Reagent Storage
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Cooling for Centrifuges
- Heads-Up Displays, Imaging Sensors
- Peltier Cooling for Machine Vision

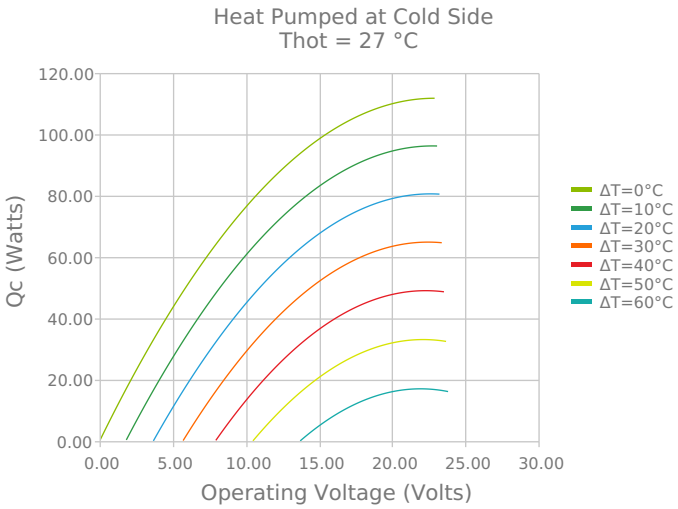


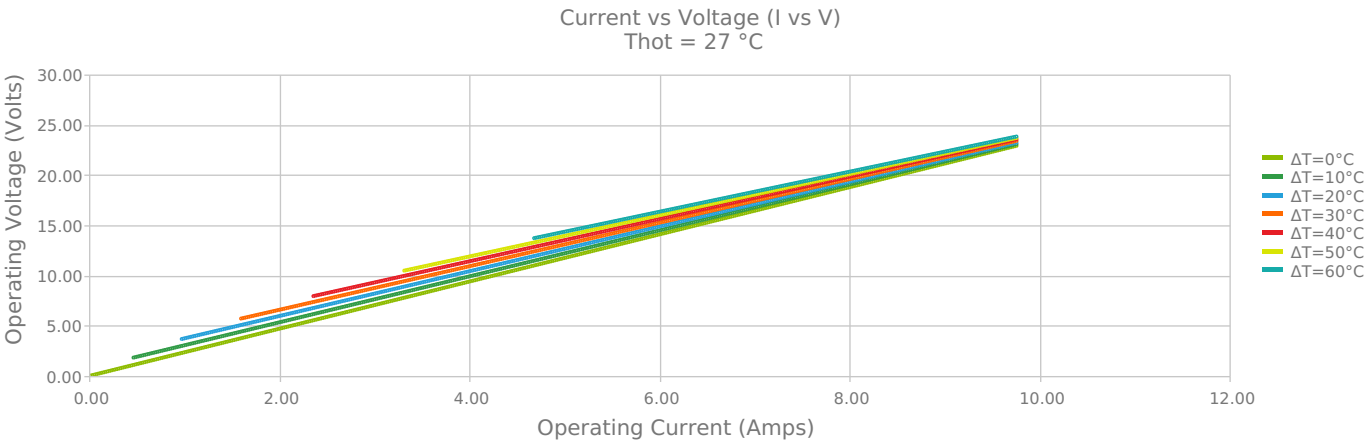
CERAMIC MATERIAL: Al_2O_3
SOLDER CONSTRUCTION: 138°C, BiSn
INCHES [MM]
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

ELECTRICAL AND THERMAL PERFORMANCE

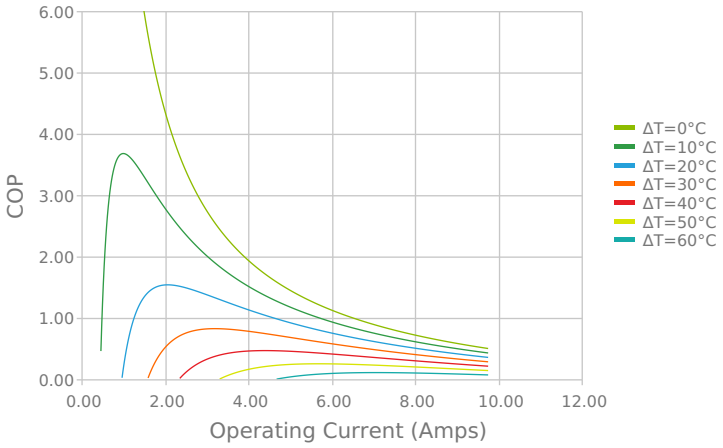
For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the HEATSINK side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.







Coefficient of Performance (COP = Qc/Pin)
Thot = 27 °C



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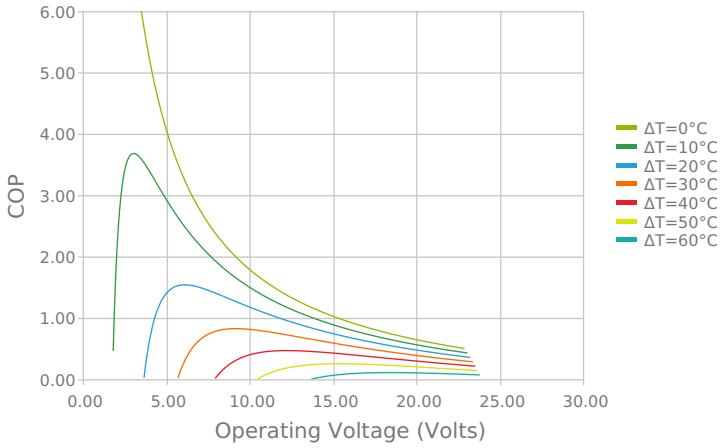
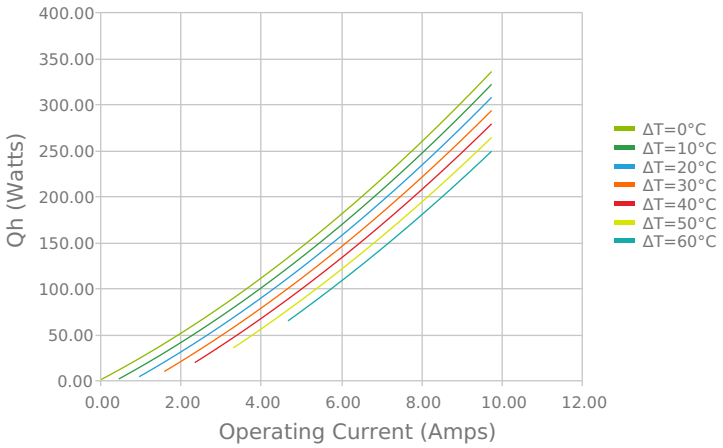


Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
Thot = 27 °C



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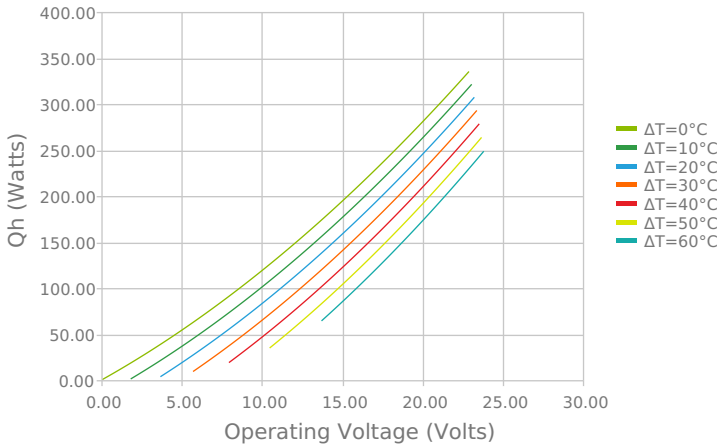
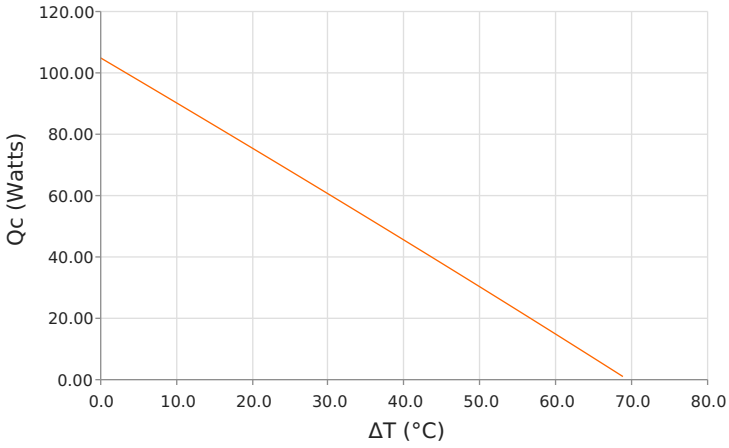
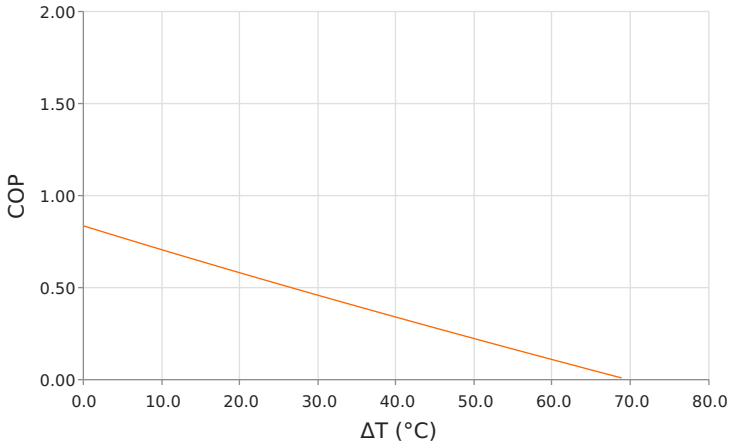


Heat Pumped at Cold Side (Qc)
Thot = 27 °C | Current = 7.3 Amps



Coefficient of Performance (COP = Qc/Pin)
Thot = 27 °C | Current = 7.3 Amps



SPECIFICATIONS*

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
Qcmax (ΔT = 0)	111.8 Watts	115.2 Watts	121.2 Watts
ΔTmax (Qc = 0)	70.5°C	73.5°C	78.8°C
Imax (I @ ΔTmax)	8.6 Amps	8.6 Amps	8.5 Amps
Vmax (V @ ΔTmax)	21.7 Volts	22.6 Volts	24.1 Volts
Module Resistance	2.35 Ohms	2.44 Ohms	2.63 Ohms
Max Operating Temperature	80 °C		
Weight	25.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
L2	3.327 ±0.013 mm 0.131 ± 0.0005 in	0.013 mm / 0.013 mm 0.0005 in / 0.0005 in	Lapped	Lapped	304.8 mm 12.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Epoxy	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

NOTES

1. Max operating temperature: 80°C
2. Do not exceed Imax or Vmax when operating module
3. Reference assembly guidelines for recommended installation
4. Solder tinning also available on metallized ceramics

Revision: 00 Date: 06-01-2022

Print Date: 06-10-2022